

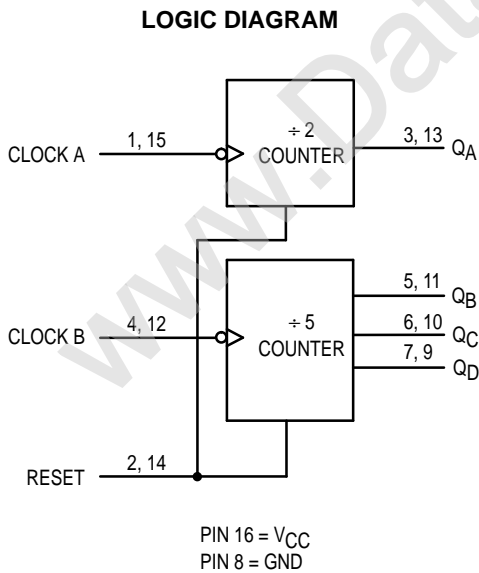
Dual 4-Stage Binary Ripple Counter with ÷ 2 and ÷ 5 Sections High-Performance Silicon-Gate CMOS

The MC54/74HC390 is identical in pinout to the LS390. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

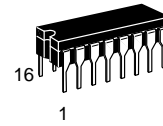
This device consists of two independent 4-bit counters, each composed of a divide-by-two and a divide-by-five section. The divide-by-two and divide-by-five counters have separate clock inputs, and can be cascaded to implement various combinations of ÷ 2 and/or ÷ 5 up to a ÷ 100 counter.

Flip-flops internal to the counters are triggered by high-to-low transitions of the clock input. A separate, asynchronous reset is provided for each 4-bit counter. State changes of the Q outputs do not occur simultaneously because of internal ripple delays. Therefore, decoded output signals are subject to decoding spikes and should not be used as clocks or strobes except when gated with the Clock of the HC390.

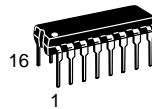
- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: 1 μ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No 7A
- Chip Complexity: 244 FETs or 61 Equivalent Gates



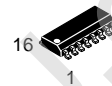
MC54/74HC390



J SUFFIX
CERAMIC PACKAGE
CASE 620-10



N SUFFIX
PLASTIC PACKAGE
CASE 648-08



D SUFFIX
SOIC PACKAGE
CASE 751B-05

ORDERING INFORMATION

| | |
|------------|---------|
| MC54HCXXXJ | Ceramic |
| MC74HCXXXN | Plastic |
| MC74HCXXXD | SOIC |

PIN ASSIGNMENT

| | | | |
|----------------------|---|----|----------------------|
| CLOCK A _a | 1 | 16 | V_{CC} |
| RESET a | 2 | 15 | CLOCK A _b |
| Q _{Aa} | 3 | 14 | RESET b |
| CLOCK B _a | 4 | 13 | Q _{Ab} |
| Q _{Ba} | 5 | 12 | CLOCK B _b |
| Q _{Ca} | 6 | 11 | Q _{Bb} |
| Q _{Da} | 7 | 10 | Q _{Cb} |
| GND | 8 | 9 | Q _{Db} |

FUNCTION TABLE

| Clock | | Reset | Action |
|--------|--------|-------|----------------------|
| A | B | | |
| X | X | H | Reset ÷ 2 and ÷ 5 |
| \sim | X | L | Increment ÷ 2 |
| X | \sim | L | Increment ÷ 5 |



MAXIMUM RATINGS*

| Symbol | Parameter | Value | Unit |
|-----------|---|-------------------------|------|
| V_{CC} | DC Supply Voltage (Referenced to GND) | - 0.5 to + 7.0 | V |
| V_{in} | DC Input Voltage (Referenced to GND) | - 1.5 to $V_{CC} + 1.5$ | V |
| V_{out} | DC Output Voltage (Referenced to GND) | - 0.5 to $V_{CC} + 0.5$ | V |
| I_{in} | DC Input Current, per Pin | ± 20 | mA |
| I_{out} | DC Output Current, per Pin | ± 25 | mA |
| I_{CC} | DC Supply Current, V_{CC} and GND Pins | ± 50 | mA |
| P_D | Power Dissipation in Still Air, Plastic or Ceramic DIP† SOIC Package† | 750 500 | mW |
| T_{stg} | Storage Temperature | - 65 to + 150 | °C |
| T_L | Lead Temperature, 1 mm from Case for 10 Seconds (Plastic or SOIC DIP) (Ceramic DIP) | 260 300 | °C |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

† Derating — Plastic DIP: - 10 mW/°C from 65° to 125° C
Ceramic DIP: - 10 mW/°C from 100° to 125° C
SOIC Package: - 7 mW/°C from 65° to 125° C

For high frequency or heavy load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit | |
|-------------------|--|--|-------------|--------------------|----|
| V_{CC} | DC Supply Voltage (Referenced to GND) | 2.0 | 6.0 | V | |
| V_{in}, V_{out} | DC Input Voltage, Output Voltage (Referenced to GND) | 0 | V_{CC} | V | |
| T_A | Operating Temperature, All Package Types | - 55 | + 125 | °C | |
| t_r, t_f | Input Rise and Fall Time (Figure 1) | $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$ | 0 0 0 | 1000 500 400 | ns |

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol | Parameter | Test Conditions | V_{CC} V | Guaranteed Limit | | | Unit |
|----------|--|---|--|------------------|---------------------------|----------------------------|---------------|
| | | | | - 55 to 25° C | $\leq 85^\circ \text{ C}$ | $\leq 125^\circ \text{ C}$ | |
| V_{IH} | Minimum High-Level Input Voltage | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 | 1.5 | 1.5 | 1.5 | V |
| | | | 4.5 | 3.15 | 3.15 | 3.15 | |
| | | | 6.0 | 4.2 | 4.2 | 4.2 | |
| V_{IL} | Maximum Low-Level Input Voltage | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 | 0.3 | 0.3 | 0.3 | V |
| | | | 4.5 | 0.9 | 0.9 | 0.9 | |
| | | | 6.0 | 1.2 | 1.2 | 1.2 | |
| V_{OH} | Minimum High-Level Output Voltage | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 | 1.9 | 1.9 | 1.9 | V |
| | | | 4.5 | 4.4 | 4.4 | 4.4 | |
| | | | 6.0 | 5.9 | 5.9 | 5.9 | |
| | | | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \leq 4.0 \text{ mA}$ $ I_{out} \leq 5.2 \text{ mA}$ | 4.5 | 3.98 | 3.84 | |
| V_{OL} | Maximum Low-Level Output Voltage | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \leq 20 \mu\text{A}$ | 2.0 | 0.1 | 0.1 | 0.1 | V |
| | | | 4.5 | 0.1 | 0.1 | 0.1 | |
| | | | 6.0 | 0.1 | 0.1 | 0.1 | |
| | | | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out} \leq 4.0 \text{ mA}$ $ I_{out} \leq 5.2 \text{ mA}$ | 4.5 | 0.26 | 0.33 | |
| I_{in} | Maximum Input Leakage Current | $V_{in} = V_{CC} \text{ or } GND$ | 6.0 | ± 0.1 | ± 1.0 | ± 1.0 | μA |
| I_{CC} | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \mu\text{A}$ | 6.0 | 8 | 80 | 160 | μA |

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

AC ELECTRICAL CHARACTERISTICS ($C_L = 50$ pF, Input $t_f = t_r = 6$ ns)

| Symbol | Parameter | VCC V | Guaranteed Limit | | | Unit |
|--------------------------|--|----------|------------------|---------|----------|------|
| | | | - 55 to 25° C | ≤ 85° C | ≤ 125° C | |
| f_{max} | Maximum Clock Frequency (50% Duty Cycle) (Figures 1 and 3) | 2.0 | 5.4 | 4.4 | 3.6 | MHz |
| | | 4.5 | 27 | 22 | 18 | |
| | | 6.0 | 32 | 26 | 21 | |
| t_{PLH} , t_{PHL} | Maximum Propagation Delay, Clock A to QA (Figures 1 and 3) | 2.0 | 120 | 150 | 180 | ns |
| | | 4.5 | 24 | 30 | 36 | |
| | | 6.0 | 20 | 26 | 31 | |
| t_{PLH} , t_{PHL} | Maximum Propagation Delay, Clock A to QC (QA connected to Clock B) (Figures 1 and 3) | 2.0 | 290 | 365 | 435 | ns |
| | | 4.5 | 58 | 73 | 87 | |
| | | 6.0 | 49 | 62 | 74 | |
| t_{PLH} , t_{PHL} | Maximum Propagation Delay, Clock B to QB (Figures 1 and 3) | 2.0 | 130 | 165 | 195 | ns |
| | | 4.5 | 26 | 33 | 39 | |
| | | 6.0 | 22 | 28 | 33 | |
| t_{PLH} , t_{PHL} | Maximum Propagation Delay, Clock B to QC (Figures 1 and 3) | 2.0 | 185 | 230 | 280 | ns |
| | | 4.5 | 37 | 46 | 56 | |
| | | 6.0 | 31 | 39 | 48 | |
| t_{PLH} , t_{PHL} | Maximum Propagation Delay, Clock B to QD (Figures 1 and 3) | 2.0 | 130 | 165 | 195 | ns |
| | | 4.5 | 26 | 33 | 39 | |
| | | 6.0 | 22 | 28 | 33 | |
| t_{PHL} | Maximum Propagation Delay, Reset to any Q (Figures 2 and 3) | 2.0 | 165 | 205 | 250 | ns |
| | | 4.5 | 33 | 41 | 50 | |
| | | 6.0 | 28 | 35 | 43 | |
| t_{TLH} , t_{THL} | Maximum Output Transition Time, Any Output (Figures 1 and 3) | 2.0 | 75 | 95 | 110 | ns |
| | | 4.5 | 15 | 19 | 22 | |
| | | 6.0 | 13 | 16 | 19 | |
| C_{in} | Maximum Input Capacitance | — | 10 | 10 | 10 | pF |

NOTES:

- For propagation delays with loads other than 50 pF, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).
- Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

| CPD | Power Dissipation Capacitance (Per Counter)* | Typical @ 25°C, VCC = 5.0 V | | | pF |
|-----|--|-----------------------------|--|--|----|
| | | 35 | | | |
| | | 35 | | | pF |

* Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$. For load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

TIMING REQUIREMENTS (Input $t_r = t_f = 6$ ns)

| Symbol | Parameter | VCC V | Guaranteed Limit | | | Unit |
|------------|---|----------|------------------|---------|----------|------|
| | | | - 55 to 25° C | ≤ 85° C | ≤ 125° C | |
| t_{rec} | Minimum Recovery Time, Reset Inactive to Clock A or Clock B (Figure 2) | 2.0 | 50 | 65 | 75 | ns |
| | | 4.5 | 10 | 13 | 15 | |
| | | 6.0 | 9 | 11 | 13 | |
| t_w | Minimum Pulse Width, Clock A, Clock B (Figure 1) | 2.0 | 80 | 100 | 120 | ns |
| | | 4.5 | 16 | 20 | 24 | |
| | | 6.0 | 14 | 17 | 20 | |
| t_w | Minimum Pulse Width, Reset (Figure 2) | 2.0 | 125 | 155 | 190 | ns |
| | | 4.5 | 25 | 31 | 38 | |
| | | 6.0 | 21 | 26 | 32 | |
| t_r, t_f | Maximum Input Rise and Fall Times (Figure 1) | 2.0 | 1000 | 1000 | 1000 | ns |
| | | 4.5 | 500 | 500 | 500 | |
| | | 6.0 | 400 | 400 | 400 | |

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

PIN DESCRIPTIONS

INPUTS

Clock A (Pins 1, 15) and Clock B (Pins 4, 15)

Clock A is the clock input to the ÷ 2 counter; Clock B is the clock input to the ÷ 5 counter. The internal flip-flops are toggled by high-to-low transitions of the clock input.

CONTROL INPUTS

Reset (Pins 2, 14)

Asynchronous reset. A high at the Reset input prevents counting, resets the internal flip-flops, and forces Q_A through Q_D low.

OUTPUTS

Q_A (Pins 3, 13)

Output of the ÷ 2 counter.

Q_B, Q_C, Q_D (Pins 5, 6, 7, 9, 10, 11)

Outputs of the ÷ 5 counter. Q_D is the most significant bit. Q_A is the least significant bit when the counter is connected for BCD output as in Figure 4. Q_B is the least significant bit when the counter is operating in the bi-quinary mode as in Figure 5.

SWITCHING WAVEFORMS

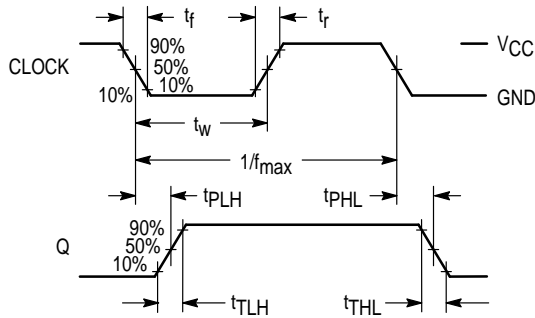


Figure 1.

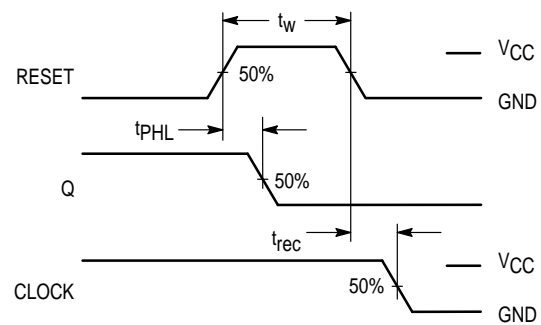
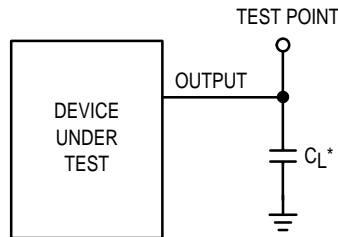


Figure 2.

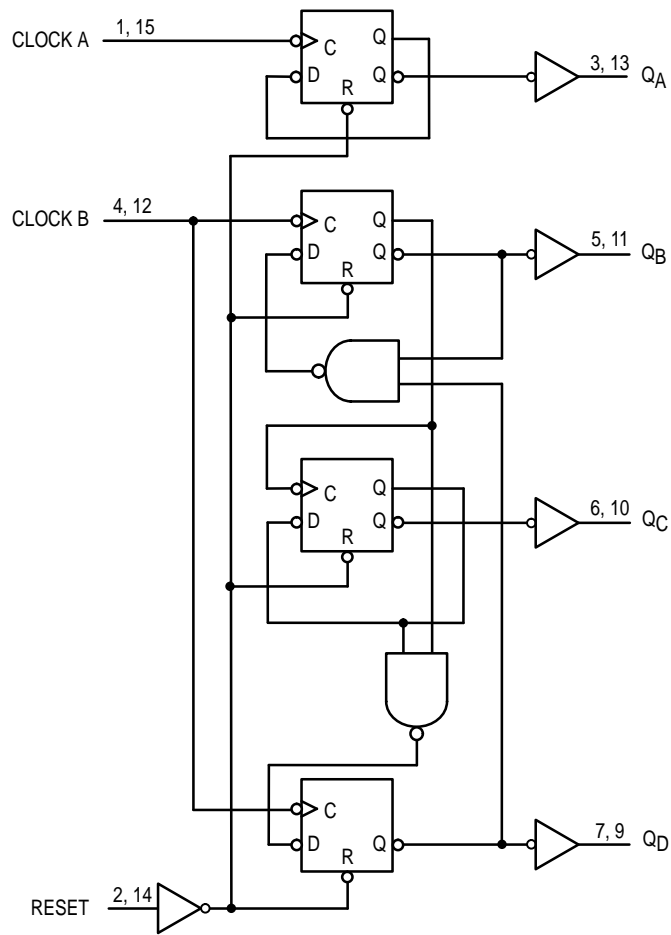
TEST CIRCUIT



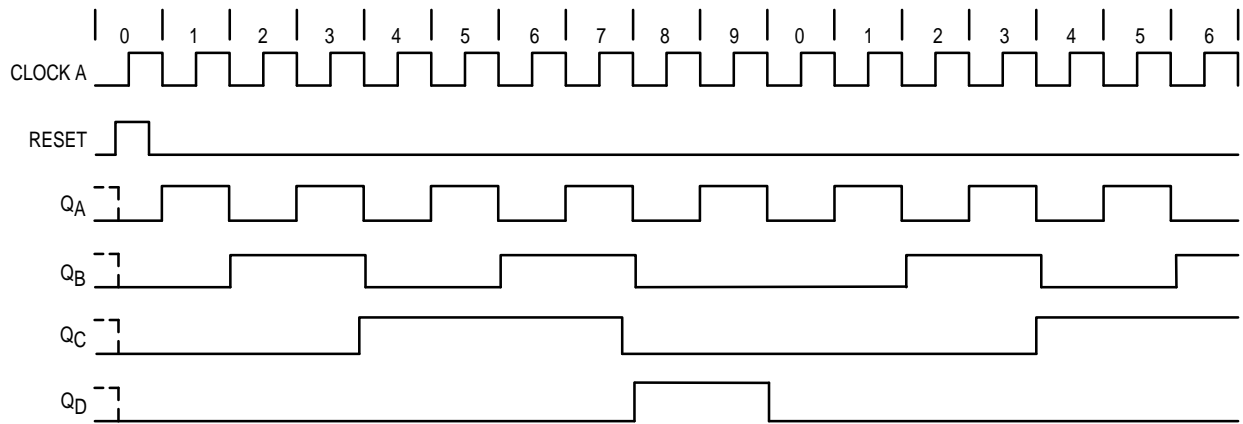
* Includes all probe and jig capacitance

Figure 3.

EXPANDED LOGIC DIAGRAM



**TIMING DIAGRAM
(Q_A Connected to Clock B)**



APPLICATIONS INFORMATION

Each half of the MC54/74HC390 has independent ÷ 2 and ÷ 5 sections (except for the Reset function). The ÷ 2 and ÷ 5 counters can be connected to give BCD or bi-quinary (2–5) count sequences. If Output Q_A is connected to the Clock B input (Figure 4), a decade divider with BCD output is obtained. The function table for the BCD count sequence is given in Table 1.

To obtain a bi-quinary count sequence, the input signals connected to the Clock B input, and output Q_D is connected to the Clock A input (Figure 5). Q_A provides a 50% duty cycle output. The bi-quinary count sequence function table is given in Table 2.

Table 1. BCD Count Sequence*

| Count | Output | | | |
|-------|----------------|----------------|----------------|----------------|
| | Q _D | Q _C | Q _B | Q _A |
| 0 | L | L | L | L |
| 1 | L | L | L | H |
| 2 | L | L | H | L |
| 3 | L | L | H | H |
| 4 | L | H | L | L |
| 5 | L | H | L | H |
| 6 | L | H | H | L |
| 7 | L | H | H | H |
| 8 | H | L | L | L |
| 9 | H | L | L | H |

* Q_A connected to Clock B input.

Table 2. Bi-Quinary Count Sequence**

| Count | Output | | | |
|-------|----------------|----------------|----------------|----------------|
| | Q _A | Q _D | Q _C | Q _B |
| 0 | L | L | L | L |
| 1 | L | L | L | H |
| 2 | L | L | H | L |
| 3 | L | L | H | H |
| 4 | L | H | L | L |
| 8 | H | L | L | L |
| 9 | H | L | L | H |
| 10 | H | L | H | L |
| 11 | H | L | H | H |
| 12 | H | H | L | L |

** Q_D connected to Clock A input.

CONNECTION DIAGRAMS

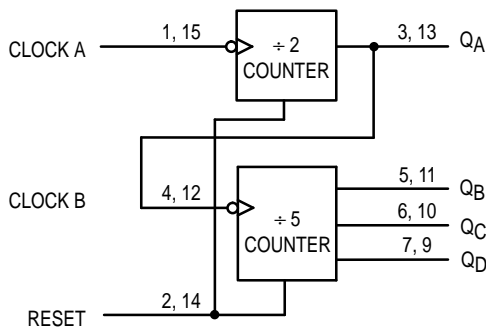


Figure 4. BCD Count

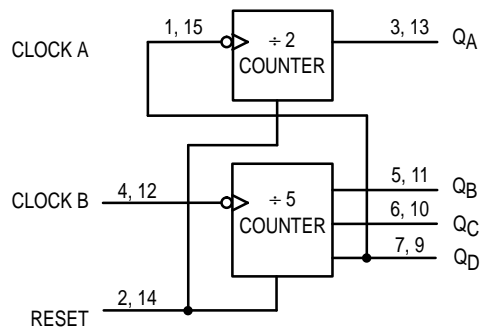



Figure 5. Bi-Quinary Count

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